

ESD9DXXC
Transient Voltage Suppressors for ESD Protection

Revision:A

General Description

The ESD9DXXC is designed to protect voltage sensitive components from ESD and transient voltage events. Excellent clamping capability, low leakage, and fast response time, make these parts ideal for ESD protection on designs where board space is at a premium. Because of its small size, it is suited for use in cellular phones, MP3 players, digital cameras and many other portable applications where board space is at a premium.

Applications

- Cellular phones
- Portable devices
- Digital cameras
- Power supplies

Features

- Small Body Outline Dimensions
- Low Body Height
- Peak Power up to 150 Watts @ 8 x 20 μ s Pulse
- Low Leakage current
- Response Time is Typically < 1 ns

Complies with the following standards
IEC61000-4-2

Level 4 15 kV (air discharge)

8 kV(contact discharge)

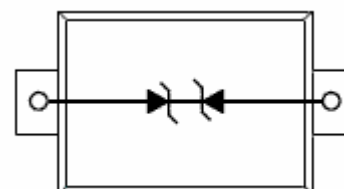
MIL STD 883E - Method 3015-7 Class 3

25 kV HBM (Human Body Model)

Functional diagram



SOD-923

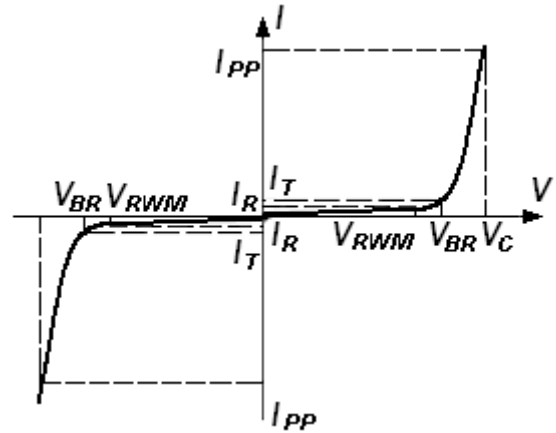


Absolute Ratings ($T_{amb}=25^{\circ}C$)

Symbol	Parameter	Value	Units	
P_{PP}	Peak Pulse Power ($t_p = 8/20\mu s$)	150	W	
T_L	Maximum lead temperature for soldering during 10s	260	$^{\circ}C$	
T_{stg}	Storage Temperature Range	-55 to +155	$^{\circ}C$	
T_{op}	Operating Temperature Range	-40 to +125	$^{\circ}C$	
T_j	Maximum junction temperature	150	$^{\circ}C$	
	IEC61000-4-2 (ESD)	air discharge contact discharge	± 15 ± 8	kV
	IEC61000-4-4 (EFT)		40	A
	ESD Voltage	Per Human Body Model Per Machine Model	25 400	kV V

Electrical Parameter

Symbol	Parameter
I_{PP}	Maximum Reverse Peak Pulse Current
V_C	Clamping Voltage @ I_{PP}
V_{RWM}	Working Peak Reverse Voltage
I_R	Maximum Reverse Leakage Current @ V_{RWM}
I_T	Test Current
V_{BR}	Breakdown Voltage @ I_T



Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified. VF = 0.9V at IF = 10mA

Part Numbers	V_{BR}			I_R	V_{RWM}	I_R	C
	Min.	Typ.	Max.				
	V	V	V				mA
ESD9D3V3C	5.1	6.0	6.8	1	3.3	1	20
ESD9D5C	5.6	6.7	7.8	1	5.0	1	11
ESD9D12C	13.3	14.5	15.7	1	12	1	9

*Surge current waveform per Figure 1.

- V_{BR} is measured with a pulse test current I_T at an ambient temperature of 25°C.

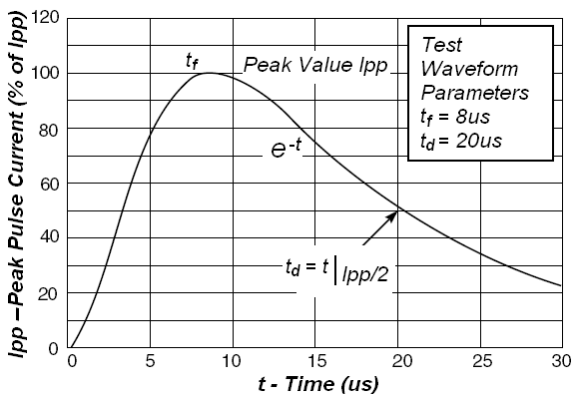


Fig1. Pulse Waveform

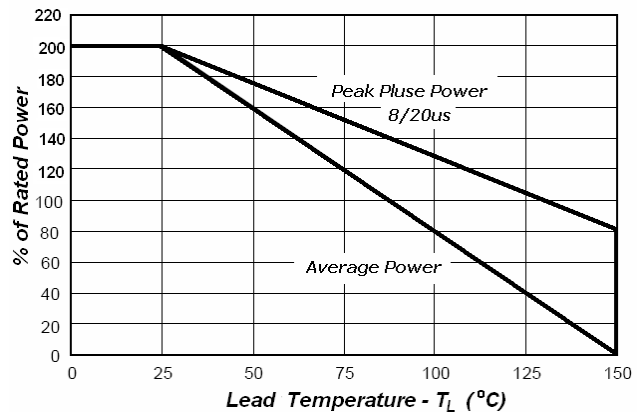


Fig2. Power Derating Curve

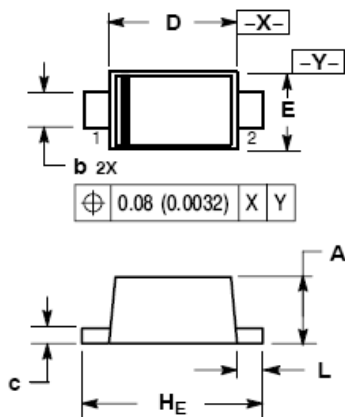
Application Note

Electrostatic discharge (ESD) is a major cause of failure in electronic systems. Transient Voltage Suppressors (TVS) are an ideal choice for ESD protection. They are capable of clamping the incoming transient to a low enough level such that damage to the protected semiconductor is prevented.

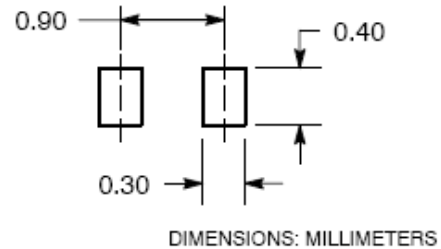
Surface mount TVS offers the best choice for minimal lead inductance. They serve as parallel protection elements, connected between the signal lines to ground. As the transient rises above the operating voltage of the device, the TVS becomes a low impedance path diverting the transient current to ground. The ESD9DXXC is the ideal board level protection of ESD sensitive semiconductor components.

The tiny SOD-923 package allows design flexibility in the design of high density boards where the space saving is at a premium. This enables to shorten the routing and contributes to hardening against ESD.

SOD-923 Mechanical Data



SOLDERING FOOTPRINT*



SOD-923

Dim	Millimeters			Inches		
	Min	Nom	Max	Min	Nom	Max
A	0.36	0.40	0.43	0.014	0.016	0.017
b	0.15	0.20	0.25	0.006	0.008	0.010
c	0.07	0.12	0.17	0.003	0.005	0.007
D	0.75	0.80	0.85	0.030	0.031	0.033
E	0.55	0.60	0.65	0.022	0.024	0.026
HE	0.95	1.00	1.05	0.037	0.039	0.041
L	0.05	0.10	0.15	0.002	0.004	0.006

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